



- A1–A2** EMS Electronic manufacturing services, PCBs and other circuit carriers
- A3** Electromechanics and system peripherals, Interconnection components
- B2–B3** Electromechanics and system peripherals, Interconnection components, Casing technology
- B3** Electromechanics and system peripherals, Interconnection components, Casing technology
- A4** Test and measurement
- A5** Power supplies
- A6/B6** Passive components
- B4** Sensor and driving technology, Microsystems and MEMS
- B4** **all halls** Automotive
- B5** **all halls** Embedded Computing
- B5** **C2–C6** Semiconductors
- B6** Displays
- C5** Wireless
- B1** **C1–C2** SEMICON Europa 2026
- all halls** ED/EDA / Services
- ICM** **Conferences**